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Courses » Semiconductor Devices and Circuits

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Unit 6 - Week 5 : Metal-Semiconductor Junctions

Course outline

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Week 5 : Metal-Semiconductor Junctions

- ☒ Junctions
- ☐ Metal Semiconductor Junctions
- ☒ Schottky Contact : Electrostatics

Assignment 5

The due date for submitting this assignment has passed.

As per our records you have not submitted this assignment.

Due on 2018-09-12, 23:59 IST.

1) Assume an arbitrary metal forms a Schottky contact with an n-type semiconductor. How does the Schottky barrier height vary if the doping in the semiconductor decreases? **1 point**

- ☐ increases
- ☐ decreases
- ☐ remains unchanged
- ☐ becomes zero

No, the answer is incorrect.

Score: 0

Accepted Answers:
remains unchanged

2) An arbitrary metal is deposited on a lightly doped n-type semiconductor. Work-function of the metal is much higher than the work-function of the semiconductor. Which of the following steps will make the metal-semiconductor contact an ohmic one? **1 point**

Assume an ideal contact with no surface states.

- ☐ Doping the semiconductor heavily (degenerate doping) with an n-type impurity near the contact region.
- ☐ Doping the semiconductor heavily with a p-type impurity far away from the contact .
- ☐ Doping the semiconductor lightly with a p-type impurity near the contact to make the semiconductor an intrinsic one.
- ☐ No further processing is required, as it is already an ohmic contact.

No, the answer is incorrect.

Score: 0

Accepted Answers:

Since the semiconductor has a high work-function, it will not form an ohmic contact with the metal.

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Quiz :
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Sessions

- ☐ increases, decreases
- ☐ decreases, decreases
- ☐ increases, increases

No, the answer is incorrect.

Score: 0

Accepted Answers:

increases, increases

4) Consider a (chromium) - (n-type silicon) metal-semiconductor junction. The semiconductor **1 point** is doped with $N_D = 10^{17} \text{ cm}^{-3}$. Calculate the Schottky barrier height (in eV) and the built-in potential (in V) at $T = 300 \text{ K}$.

Use the following parameters, if required:

Work-function of chromium = 4.5 eV

Electron affinity of silicon = 4.05 eV

Band gap of silicon = 1.12 eV

$N_C = 2.82 \times 10^{19} / \text{cc}$, $N_V = 1.83 \times 10^{19} / \text{cc}$ (for silicon)

Dielectric constant of silicon = 11.9.

- ☐ 0.35, 0.2
- ☐ 0.45, 0.3
- ☐ 0.67, 0.53
- ☐ 0.76, 0.62

No, the answer is incorrect.

Score: 0

Accepted Answers:

0.45, 0.3

5) Consider the metal-semiconductor junction given in the previous question (question no. 4). **1 point** Instead of n-type doping, now consider the p-type doped Si with the dopant concentration, $N_A = 10^{17} \text{ cm}^{-3}$. What will be the Schottky barrier height (in eV) and the built-in potential (in V)?

- ☐ 0.35, 0.2
- ☐ 0.45, 0.3
- ☐ 0.67, 0.53
- ☐ 0.76, 0.62

No, the answer is incorrect.

Score: 0

Accepted Answers:

0.67, 0.53

6) Consider the (chromium) - (n-type Si) MS junction given in the question number 4. **1 point** Calculate the following quantities when the junction is reverse biased with 5 V :

i) the depletion layer width (in μm)

ii) the electric field at the metal semiconductor interface (in V/cm)

- ☐ i) 0.26
- ii) 3.95e5
- ☐ i) 0.53
- ii) 1e5
- ☐ i) 0.06
- ii) 9.12e4

- ☐ i) 0.02
☐ ii) 1e4

No, the answer is incorrect.

Score: 0

Accepted Answers:

- i) 0.26
 ii) 3.95e5

7) Consider the (chromium) - (n-Si) MS junction given in question 4. The junction is subjected **1 point** to a 5 V reverse bias. Calculate i) the potential drop across the semiconductor (in V) and the junction capacitance per unit area (in nF/cm^2).

- ☐ i) zero
☐ ii) zero
☐ i) 0.3
☐ ii) 100
☐ i) 4.7
☐ ii) 28.9
☐ i) 5.3
☐ ii) 40.5

No, the answer is incorrect.

Score: 0

Accepted Answers:

- i) 5.3
 ii) 40.5

8) The capacitance, C of a Schottky diode is given by the relation $\frac{1}{C^2} = a - bV$, **1 point** with V the applied voltage. a and b are constant coefficients. Calculate i) the built-in potential (ϕ_{bi}) and ii) the donor concentration (N_D). Assume, the permittivity of semiconductor = ϵ_s and the junction cross-section area = A .

- ☐ i) $\phi_{bi} = \frac{\epsilon_s q N_D}{2b}$ ii) $N_D = \frac{2}{\epsilon_s N_D q a}$
☐ i) $\phi_{bi} = \frac{\epsilon_s A^2 q N_D a}{2}$ ii) $N_D = \frac{2}{\epsilon_s A^2 q b}$
☐ i) $\phi_{bi} = \frac{2}{\epsilon_s q N_D a}$ ii) $N_D = \frac{abA^2}{\epsilon_s qb}$
☐ i) $\phi_{bi} = \frac{2N_D}{\epsilon_s q A a}$ ii) $\frac{\epsilon_s}{q N_D A b}$

No, the answer is incorrect.

Score: 0

Accepted Answers:

- i) $\phi_{bi} = \frac{\epsilon_s A^2 q N_D a}{2}$ ii) $N_D = \frac{2}{\epsilon_s A^2 q b}$

9) A metal semiconductor contact is made with Au (work function = 5.1 eV) and n doped Si **1 point** with $N_D = 1e15/cc$. If the metal contact is kept 5 V below the semiconductor, what is the electric field in the semiconductor at the distance of $1\text{ }\mu\text{m}$ from the junction at $T = 300\text{ K}$? Assume, $N_C = 2.82e19/cc$, electron affinity of Si = 4.05 eV and the relative permittivity of Si = 11.8

- ☐ -1.52 kV/cm

 1.52 kV/cm  -26.76 kV/cm  26.76 kV/cm

No, the answer is incorrect.

Score: 0

Accepted Answers:

-26.76 kV/cm

10) Which of the following is **not** correct regarding an M-S junction?

1 point



Thermionic emission depends on the shape of the band bending inside the semiconductor near the junction.



Tunneling current through a triangular barrier at the junction increases with the doping concentration in the semiconductor.



Diffusion transport through a junction is negligible in case of reverse bias.



Thermionic emission transport enhances with the increase in temperature.

No, the answer is incorrect.

Score: 0

Accepted Answers:

Thermionic emission depends on the shape of the band bending inside the semiconductor near the junction.

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